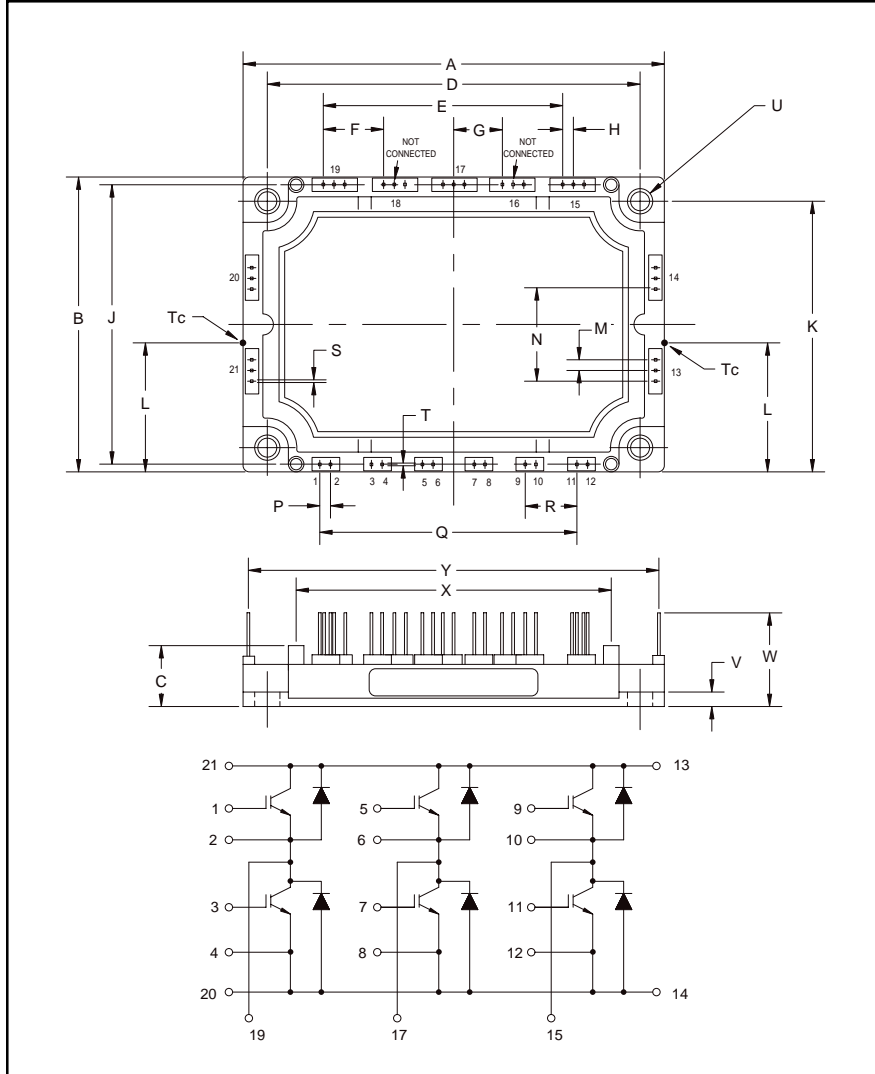


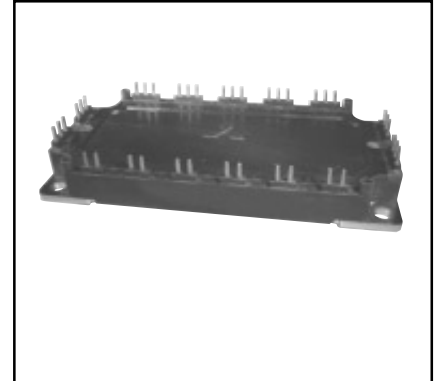
Trench Gate Design Six IGBTMOD™ 100 Amperes/1200 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	4.78	121.5
B	2.42	61.5
C	0.67	17.0
D	4.33±0.01	110.0±0.25
E	3.00	76.2
F	0.75	19.05
G	0.60	15.24
H	0.15	3.81
J	2.26	57.5
K	1.97±0.01	50.0±0.25
L	1.07	27.0

Dimensions	Inches	Millimeters
M	0.15	3.81
N	0.75	19.05
P	0.15	3.81
Q	3.00	76.2
R	0.60	15.24
S	0.45	1.15
T	0.04	1.0
U	0.22 Dia.	5.5 Dia.
V	0.12	3.0
W	0.81	20.5
X	3.72	94.5
Y	4.62	118.11



Description:

Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of six IGBT Transistors in a three phase bridge configuration, with each transistor having a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- Low Drive Power
- Low $V_{CE(sat)}$
- Discrete Super-Fast Recovery Free-Wheel Diode
- Isolated Baseplate for Easy Heat Sinking

Applications:

- AC Motor Control
- UPS
- Battery Powered Supplies

Ordering Information:

Example: Select the complete module number you desire from the table - i.e. CM100TJ-24F is a 1200V (V_{CES}), 100 Ampere Six-IGBT IGBTMOD™ Power Module.

Type	Current Rating Amperes	V_{CES} Volts (x 50)
CM	100	24



Powerex, Inc., 200 Hillis Street, Youngwood, Pennsylvania 15697-1800 (724) 925-7272

CM100TJ-24F
Trench Gate Design Six IGBTMOD™
 100 Amperes/1200 Volts

Absolute Maximum Ratings, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Ratings	Symbol	CM100TJ-24F	Units
Junction Temperature	T_j	-40 to 150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 to 125	$^\circ\text{C}$
Collector-Emitter Voltage (G-E SHORT)	V_{CES}	1200	Volts
Gate-Emitter Voltage (C-E SHORT)	V_{GES}	± 20	Volts
Collector Current ($T_c = 25^\circ\text{C}$)	I_C	100	Amperes
Peak Collector Current ($T_j \leq 150^\circ\text{C}$)	I_{CM}	200*	Amperes
Emitter Current ($T_c = 25^\circ\text{C}$)**	I_E	100	Amperes
Peak Emitter Current**	I_{EM}	200*	Amperes
Maximum Collector Dissipation ($T_j < 150^\circ\text{C}$) ($T_c = 25^\circ\text{C}$)	P_C	390	Watts
Mounting Torque, M5 Mounting	-	31	in-lb
Weight	-	300	Grams
Isolation Voltage (Main Terminal to Baseplate, AC 1 min.)	V_{iso}	2500	Volts

Static Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	I_{CES}	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	1	mA
Gate Leakage Current	I_{GES}	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	20	μA
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$I_C = 10\text{mA}, V_{CE} = 10V$	5	6	7	Volts
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 100\text{A}, V_{GE} = 15V, T_j = 25^\circ\text{C}$	-	1.8	2.4	Volts
		$I_C = 100\text{A}, V_{GE} = 15V, T_j = 125^\circ\text{C}$	-	1.9	-	Volts
Total Gate Charge	Q_G	$V_{CC} = 600V, I_C = 100\text{A}, V_{GE} = 15V$	-	1100	-	nC
Emitter-Collector Voltage**	V_{EC}	$I_E = 100\text{A}, V_{GE} = 0V$	-	-	3.3	Volts

* Pulse width and repetition rate should be such that the device junction temperature (T_j) does not exceed $T_{j(max)}$ rating.

** Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).



Powerex, Inc., 200 Hillis Street, Youngwood, Pennsylvania 15697-1800 (724) 925-7272

CM100TJ-24F
Trench Gate Design Six IGBTMOD™
 100 Amperes/1200 Volts

Dynamic Electrical Characteristics, $T_j = 25\text{ °C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units	
Input Capacitance	C_{ies}		–	–	39	nf	
Output Capacitance	C_{oes}	$V_{CE} = 10V, V_{GE} = 0V, f = 1MHz$	–	–	1.7	nf	
Reverse Transfer Capacitance	C_{res}		–	–	1.6	nf	
Inductive	Turn-on Delay Time	$t_{d(on)}$	$V_{CC} = 600V,$	–	–	100	ns
Load	Rise Time	t_r	$I_C = 100A,$	–	–	50	ns
Switch	Turn-off Delay Time	$t_{d(off)}$	$V_{GE1} = V_{GE2} = 15V,$	–	–	400	ns
Times	Fall Time	t_f	$R_G = 3.1\Omega,$	–	–	300	ns
Diode Reverse Recovery Time**	t_{rr}	Inductive Load		–	–	150	ns
Diode Reverse Recovery Charge**	Q_{rr}	Switching Operation		–	4.1	–	μC

Thermal and Mechanical Characteristics, $T_j = 25\text{ °C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{th(j-c)Q}$	Per IGBT 1/6 Module, T_C Reference Point per Outline Drawing	–	–	0.32	$^{\circ}C/W$
Thermal Resistance, Junction to Case	$R_{th(j-c)D}$	Per FWDi 1/6 Module, T_C Reference Point per Outline drawing	–	–	0.36	$^{\circ}C/W$
Thermal Resistance, Junction to Case	$R_{th(j-c)'Q}$	Per IGBT 1/6 Module, T_C Reference Point Under Chip	–	0.18	–	$^{\circ}C/W$
Thermal Resistance, Junction to Case	$R_{th(j-c)D}$	Per FWDi 1/6 Module, T_C Reference Point Under Chip	–	0.20	–	$^{\circ}C/W$
Contact Thermal Resistance	$R_{th(c-f)}$	Per Module, Thermal Grease Applied	–	0.13	–	$^{\circ}C/W$

** Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).



Powerex, Inc., 200 Hillis Street, Youngwood, Pennsylvania 15697-1800 (724) 925-7272

CM100TJ-24F
Trench Gate Design Six IGBTMOD™
 100 Amperes/1200 Volts

